

ORGANIZING INFORMATION

THE CONFERENCE IS HELD AT:

Střední škola informatiky
Čichnova 23, 624 00 BRNO - Komín

How to get there: by a car (see incl. plan)

From the Brno Trade Fair Exhibition Centre go in direction Brno-dam. After approx. 4km you will see the OPEL car shop centre, on the left side.

At the crossroads in front of the OPEL go to the left, at the next crossroads to the right and on the right side you will see an educational centre:

Střední škola informatiky,
street Čichnova 23, BRNO-Komín

BINDING APPLICATIONS:

Will be mailed together with obligatory demand for accommodation with meals before **October 18, 2013** to the address:

SMT-INFO consortium
Údolní 53, 602 00 BRNO
CZECH REPUBLIC
e-mail: smtinfo@nexta.cz
fax: 00420-546 211 009

Accommodation with meals:

Participants will be accommodated in the BOBY CENTRUM Brno ***

Registration:

In the conference hall

October 22, 2013 8.15–8.30 a.m.

PROFESSIONAL GUARANTOR:

SMT-INFO, Údolní 53, 602 00 BRNO
CZECH REPUBLIC

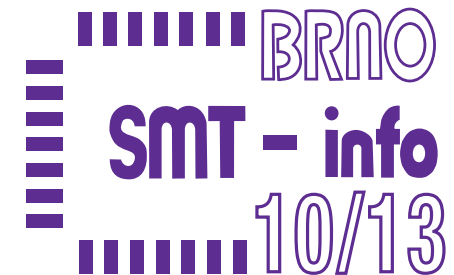
tel.: 00420-541 146 113
mobil: 00420-602 542 966
fax: 00420-546 211 009
e-mail: smtinfo@nexta.cz
Internet: www.smtinfo.cz

SMT-INFO CONSORTIUM

in cooperation with

**FEKT VUT Brno
and
SŠ INFORMATIKY BRNO**

have the pleasure to invite you
to participate in the international conference



SOLDERING AND CLEANING PCB's IN ELECTRONICS

NEW TRENDS IN MICROELECTRONICS

BRNO, October 22, 2013
SŠ informatiky
Čichnova 23, Brno-Komín

event code 10/13

SMT-INFO consortium
Údolní 53
602 00 BRNO
Czech Republic

CONFERENCE ORIENTATION:

- SOLDERING AND CLEANING IN ELECTRONICS
- NEW TRENDS IN MICROELECTRONICS
- TECHNIQUES IN REPAIRING

PROFESSIONAL OFFER

- Conference participants will be acquainted with the latest information on above mentioned topics presented by specialist from prestigious companies.
- In a room adjacent the lecture theatre, the following company stands will be installed and professional literature and demonstration equipment will be offered there:

ACC SILICONES	LÜKON THERMAL SOLUTIONS
ADOPT SMT EUROPE	PAN ELECTRONICS
AMTECH	VÚB
DCT CZECH	ULBRICH HYDROAUTOMATIK
LASERJOB	

- Advertisement tables will be available for the conference participants and visitors, providing propagation of their own products and offer of non-used/used technological equipment and services.

THEMATIC ORIENTATION OF OTHER EVENTS

ORGANIZED BY SMT-INFO:

SMT-INFO 02/2014 Brno, February 11, 2014
Technical and Business Seminar

- PCB DESIGN SYSTEMS
- COMPLEX PRODUCTION LINES FOR MODERN ASSEMBLY
- INSPECTION SYSTEMS

PROFESSIONAL GUARANTOR:

SMT-INFO consortium, Údolní 53, 602 00 Brno

mobil: 00420-602 542 966

fax: 00420-546 211 009

e-mail: smtinfo@nexta.cz

CONFERENCE SCHEDULE

Tuesday, October 22, 2013

- 8.30 - Conference Opening
- 8.40 - BUT-Cooperation Possibilities with Industry in Assembly Techniques Area /J. Šandera, J. Starý, FEKT VUT Brno/
- 8.50 - Requirements for Soldered Electronic Assemblies IPC:2010, IEC:2013 and ČSN:2013 /K. Jurák, Praha, Z. Nejezchlebová, ÚNMZ Praha/
- 9.10 - New Lead-free Alloys /C. Hoppenbrouwers, ALPHA (an Alent plc Company) Europe, M. Cichra, ERMEG Liberec /
- 10.10 - Coffee, Refreshment
- 10.30 - Advanced Stencil Solutions for Complex PCB Boards /A. Axmann, LASERJOB, Furstafeldbruck/
- 11.10 - SHENMAO – New Solder Pastes Generation /J. Jánošík, AMTECH Brno/
- 11.30 - Reduced Floor Space Requirements for Thermal Processes > 20 min (curing, drying etc.) /P. Heilmann, LÜKON THERMAL SOLUTIONS, Täuffelen /
- 11.50 - Discussion
- 12.00 - Selective Solder Waves from ATF /M. Abel, ABE.TEC Pardubice/
- 12.20 - ESD Clothes CleverTex® /M. Zubec, VUB Ústí nad Orlicí /
- 12.40 - Redeemed Putting in Innovation. ERSA Machines and Causes of Success /M. Duda, PBT Rožnov p. Radh. /
- 13.00 - Lunch
- 13.40 - Development in PCBs Cleaning, ROSE TESTER 32 /D. Joura, DCT Czech, Černá Hora/
- 14.00 - New Materials for Quickly Cured VOC – free PCB Coatings /R. Příklad, ACC SILICONES Brno/
- 14.20 - Can you Make Stencil Cleaning and PCB Defluxing together in a one Cleaning Machine ? /M. Šaffer, PBT Rožnov p. Radh./
- 14.40 - HERAEUS Solder Paste with Longer Stencil Lifetime /M. Galajda, SMT SERVICE Košice/
- 14.55 - Heating Factor and Solder Joint Quality /J. Starý FEKT VUT Brno, M. Dosedla FEI Brno, Z. Jurčík, Honeywell Brno/
- 15.10 - Conference Closing, Discussion
- 15.30 - Coffee, Refreshment

Lectures in English and German will be interpreted.

Program changes reserved.

Obligatory application for international conference

**SOLDERING AND CLEANING PCB's
IN ELECTRONICS**

NEW TRENDS IN MICROELECTRONICS

October 22, 2013

Name and surname, title

Factory name and address (ZIP code)

Job function

Telephone Telefax

E-mail

1. Accommodation

from 21 to 22 October 2013 **yes-no**

2. Lunch

October 22, 2013 **yes-no**

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Participant signature Stamp and signature of the organization